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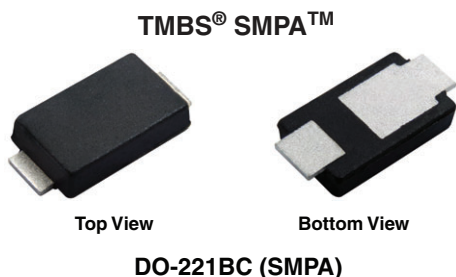
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Surface Mount Trench MOS Barrier Schottky Rectifier



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

MECHANICAL DATA

Case: DO-221BC (SMPA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
V_{RRM}	60 V
I_{FSM}	100 A
V_F at $I_F = 8.0$ A ($T_A = 125$ °C)	0.49 V
T_J max.	150 °C
Package	DO-221BC (SMPA)
Diode variation	Single die

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V8PA6	UNIT
Device marking code		V86	
Maximum repetitive peak reverse voltage	V_{RRM}	60	V
Maximum DC forward current	$I_{F(AV)}^{(1)}$	8.0	A
	$I_{F(AV)}^{(2)}$	3.2	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	100	A
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +150	°C

Notes

(1) Units mounted on 3 cm x 3 cm aluminum PCB

(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.48	-	V
	I _F = 8.0 A			0.55	0.63	
	I _F = 4.0 A	T _A = 125 °C		0.38	-	
	I _F = 8.0 A			0.49	0.57	
Reverse current	V _R = 60 V	T _A = 25 °C	I _R ⁽²⁾	-	0.6	mA
		T _A = 125 °C		14	30	
Typical junction capacitance	4.0 V, 1 MHz		C _J	1030	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	V8PA6	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	100	$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(3)}$	5	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V8PA6-M3/I	0.032	I	14 000	13" diameter plastic tape and reel
V8PA6HM3/I ⁽¹⁾	0.032	I	14 000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

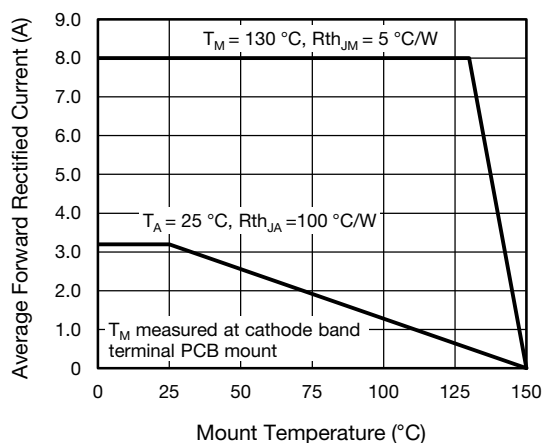
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)


Fig. 1 - Maximum Forward Current Derating Curve

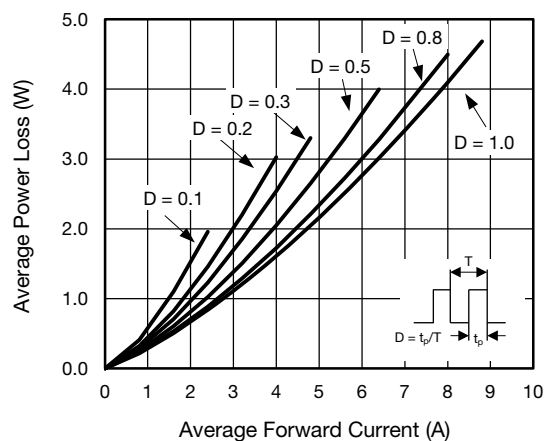


Fig. 2 - Forward Power Loss Characteristics

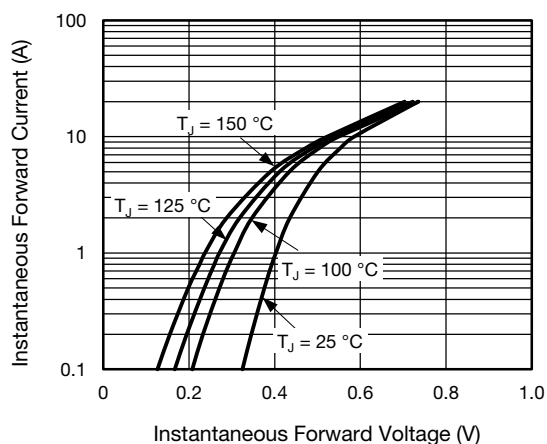


Fig. 3 - Typical Instantaneous Forward Characteristics

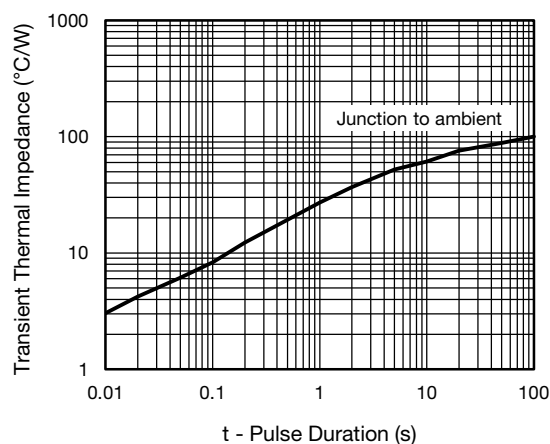


Fig. 6 - Typical Transient Thermal Impedance

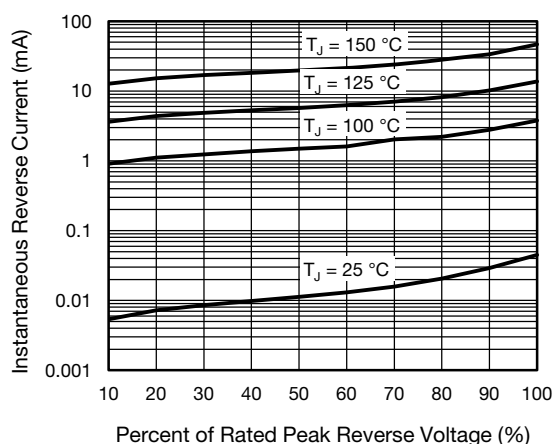


Fig. 4 - Typical Reverse Leakage Characteristics

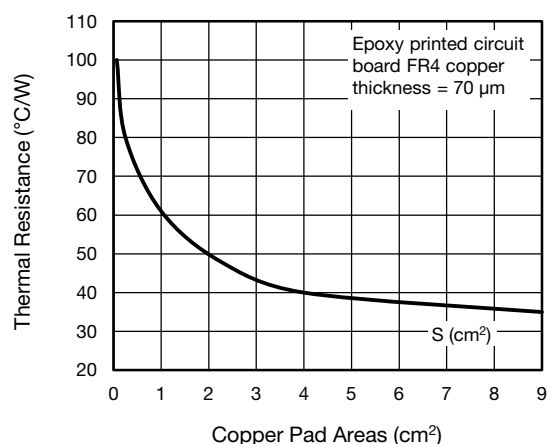


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

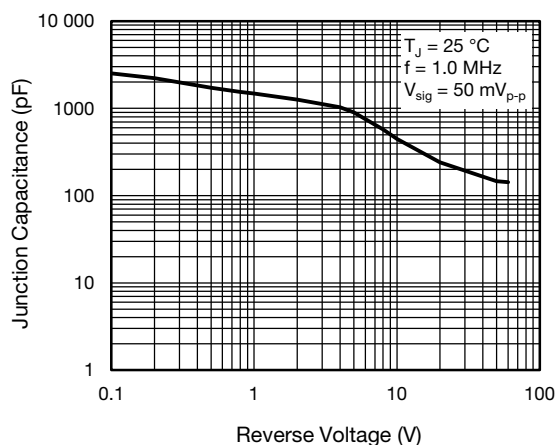
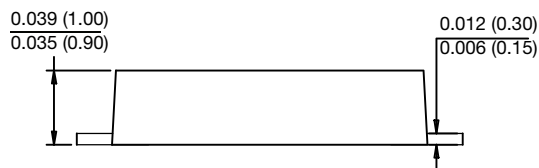
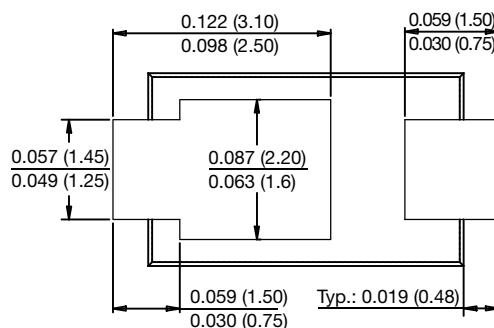
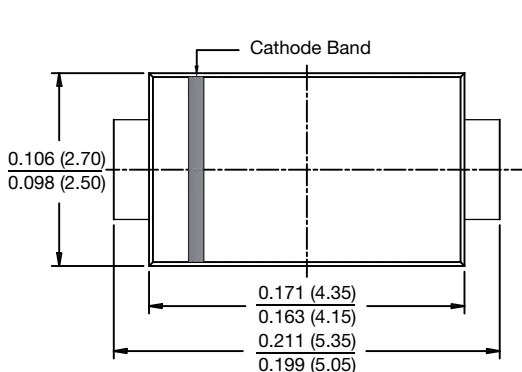


Fig. 5 - Typical Junction Capacitance

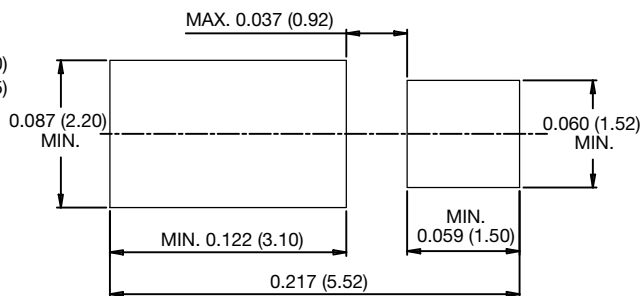


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221BC (SMPA)



Mounting Pad Layout





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